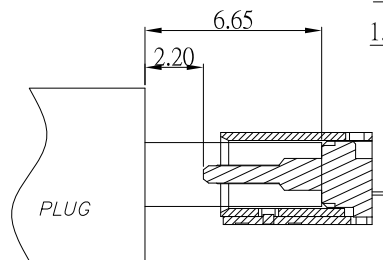
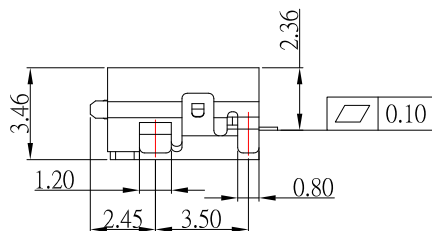
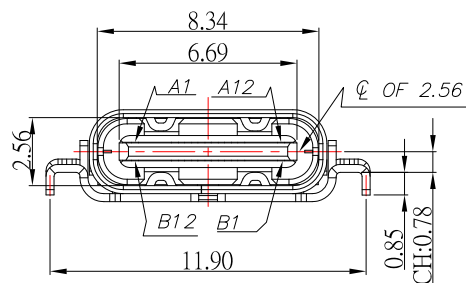
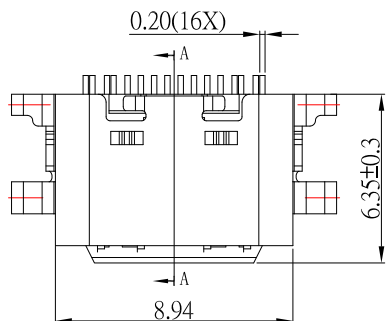




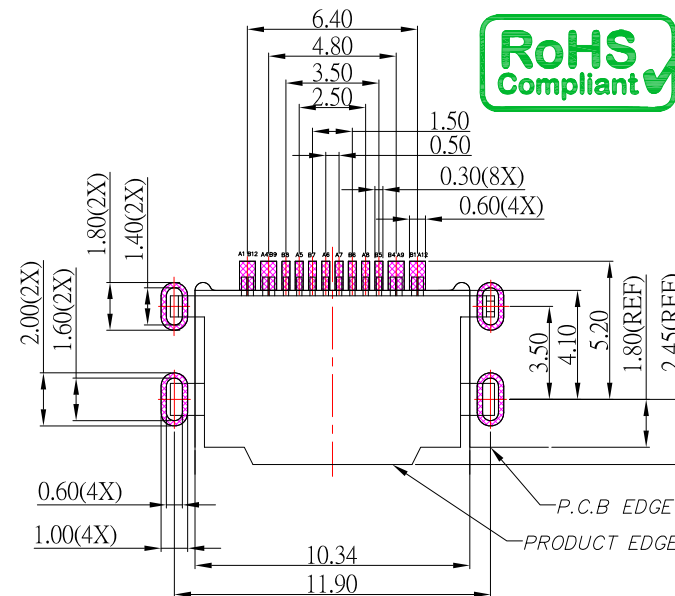
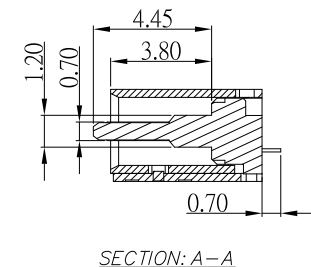
SBC-160M18H-20x-S331

鍍層厚度:

Blank	: 1u"
2	: 15u"
3	: 30u"



AFTER MATING



RECOMMENDED P.C.B. LAYOUT

SPECIFICATIONS

Electrical:

1. Rating: 5.0 V, 5.0 A
2. Dielectric Withstand Voltage: 100V AC
3. Contact Resistance: 40 mΩ Max
4. Insulation Resistance: 100 MΩ Min

Mechanical:

1. Connector Mate and Unmate Force
 - 1.1 Mate force: 5~20 N
 - 1.2 Unmate force: 8~20 N

Material:

1. Housing: LCP
2. Contact: C18150
3. Shell: SUS

Finish:

1. Contact: Plated Gold in Mating Area ;
Gold Plated on Solder Balls ;
Nickel under plated overall
2. Shell: Nickel under Plated surface layer

USB TYPE-C PIN ASSIGNMENTS

PIN NUMBER	SIGNAL NAME	PIN NUMBER	SIGNAL NAME
A1	GND	B12	GND
A4	VBUS	B9	VBUS
A5	CC1	B8	SBU2
A6	Dp1	B7	Dn2
A7	Dn1	B6	Dp2
A8	SBU1	B5	CC2
A9	VBUS	B4	VBUS
A12	GND	B1	GND



TOLERANCE UNLESS OTHERWISE STATED:

Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3°

3RD. ANGEL'S



UNITS MM

DRAWN BY: Jack Lu
CHECKED BY: Jacky Chen
APPROVED BY: Tony Kao

DATE: 03/16/23
DATE: 03/16/23
DATE: 03/16/23

MAT'L
FINISH
SCALE: 1 : 1
SHEET NO. 1 of 1

TITLE: CONNECTOR
MODLE: USB TYPE C 2.0 沉板上H2.36mm 高導電銅
DWG NO. SBC-160M18H-20x-S331
PART NO. SBC-160M18H-20x-S331

SIZE: A4
VER: R1

ITEM NO.	DESCRIPTION	DRAWN	DATE
1	新增CH尺寸	Jack	031623